





#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

#### Product Summary (@TA = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> (mA)	V <sub>F(MAX)</sub> (V)	I <sub>R(MAX)</sub> (μA)
40	250	0.6	5

## **Features and Benefits**

- Low Forward-Voltage Drop
- Guard-Ring Construction for Transient Protection
- Negligible Reverse-Recovery Time
- Low Reverse Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Applications**

- SMPS
- DC-DC Converter
- Freewheeling Diodes
- Reverse Polarity Protection
- Blocking Diodes

#### **Mechanical Data**

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish—Matte Tin Annealed over Alloy 42 Leadframe.
   Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.002 grams (Approximate)



Top View



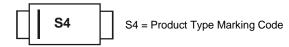
### Ordering Information (Note 5)

Part Number	Packaging	Shipping
SDM20U40Q-7	SOD523	3,000/Tape & Reel
SDM20U40Q-13	SOD523	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**





## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Forward Continuous Current (Note 6)	I <sub>O</sub>	250	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	1.0	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P <sub>D</sub>	150	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\Theta JA}$	667	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +125	°C

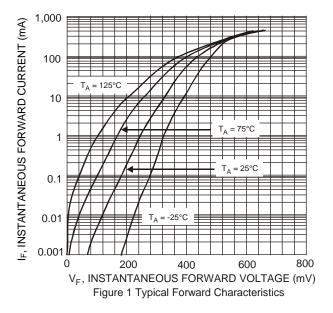
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

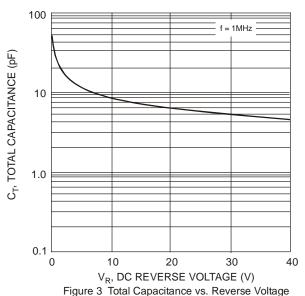
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	40	_	_	V	$I_R = 10\mu A$
Forward Voltage Drop	V <sub>F</sub>	_	_	0.35 0.37 0.60	V	$I_F = 10mA$ $I_F = 20mA$ $I_F = 200mA$
Peak Reverse Current (Note 7)	I <sub>R</sub>	_	_	5 1	μΑ μΑ	$V_R = 30V$ $V_R = 10V$
Total Capacitance	C <sub>T</sub>	_	50	_	pF	$V_R = 0V$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>RR</sub>	_	10	_	ns	$I_F = I_R = 200 \text{mA},$ $I_{RR} = 0.1 \times I_R, R_L = 100 \Omega$

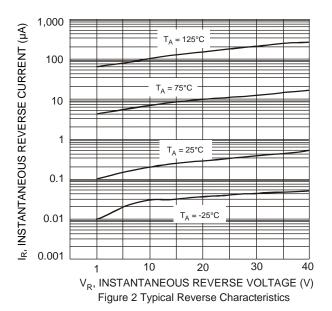
Notes:

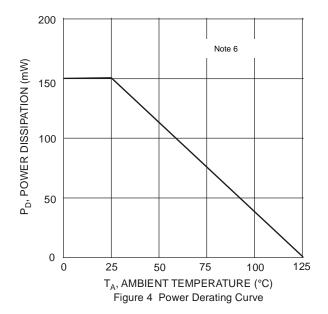
<sup>6.</sup> Device mounted on FR-4 board with recommended pad layout, which can be found at http://www.diodes.com/package-outlines.html. 7. Short duration pulse test used so as to minimize self-heating effect.









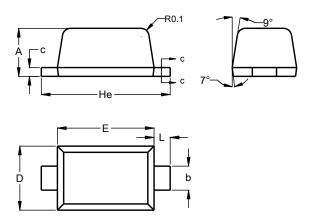




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOD523

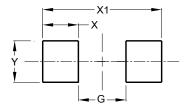


SOD523				
Dim	Min	Max		
Α	0.55	0.65		
b	0.26	0.34		
С	0.11	0.17		
D	0.75	0.85		
E	1.15	1.25		
He	1.55	1.65		
L	0.10	0.30		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOD523



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Υ	0.70



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